ULC1811CDNQ

1-Line Ultra Low Capacitance Bi-directional TVS Diode

Features

- Ultra small package: 1.0x0.6x0.5mm
- Ultra low capacitance: 0.3pF typical
- Ultra low leakage: nA level
- Operating voltage: 18V
- Low clamping voltage
- 2-pin leadless package
- Complies with following standards:

  IEC 61000-4-2 (ESD) immunity test

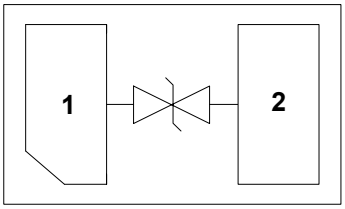
  Air discharge: ±25kV

  Contact discharge: ±15kV
- RoHS Compliant
- AEC-Q101 qualified

Dimensions DFN1006



Pin Configuration



Applications

- Antenna
- Cellular Handsets and Accessories
- Display Ports
- Digital Visual Interface (DVI)
- PCI Express and Serial SATA Ports
- Digital Camera

Mechanical Characteristics

- Package: DFN1006-2 (1.0×0.6×0.5mm)
- Lead Finish: NiPdAu
- Case Material: “Green” Molding Compound.
- Moisture Sensitivity: Level 3 per J-STD-020
- Quantity Per Reel : 10,000pcs
- Reel Size: 7 inch
- Device Marking: R18

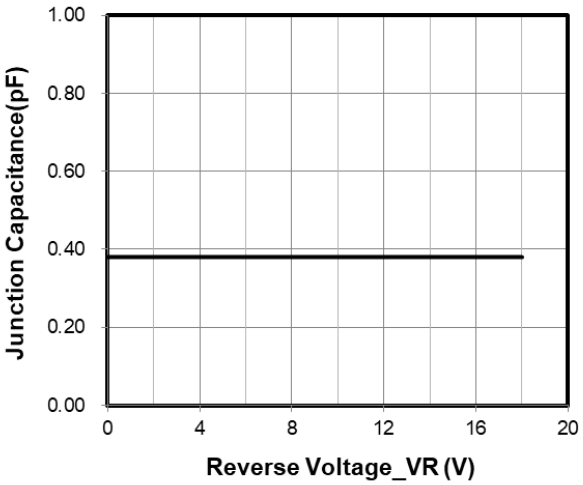
Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	Ppp	80	W
ESD per IEC 61000−4−2 (Air)	V_{ESD}	± 25	Kv
ESD per IEC 61000−4−2 (Contact)		± 15	
Operating Temperature Range	T_J	-55 to +125	℃
Storage Temperature Range	T_{STJ}	-55 to +150	℃

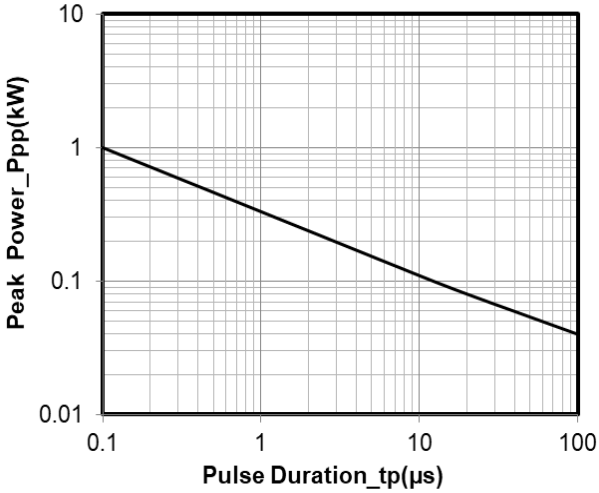
Electrical Characteristics(TA=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				18	V
Breakdown Voltage	V_{BR}	I_T = 1mA	19.5			V
Reverse Leakage Current	I_R	V_{RWM} = 18V			0.2	μA
Clamping Voltage	V_C	I_{PP} = 2A (8 x 20 μs pulse)			40	V
Junction Capacitance	C_J	V_R = 0V, f = 1MHz		0.3		pF

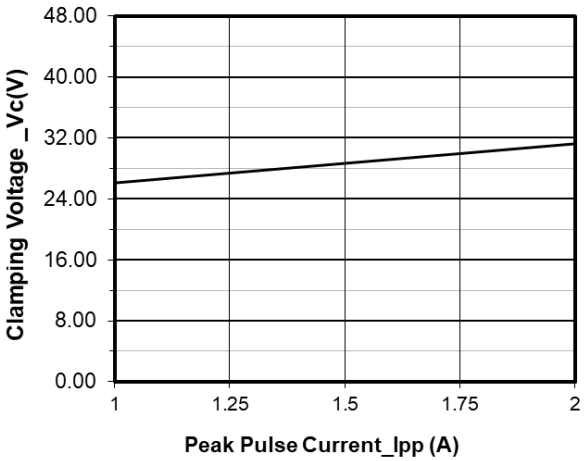
Typical Performance Characteristics (TA=25°C unless otherwise Specified)



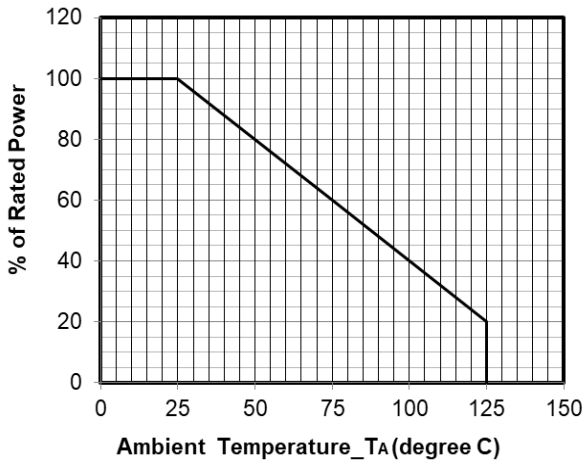
Junction Capacitance vs. Reverse Voltage



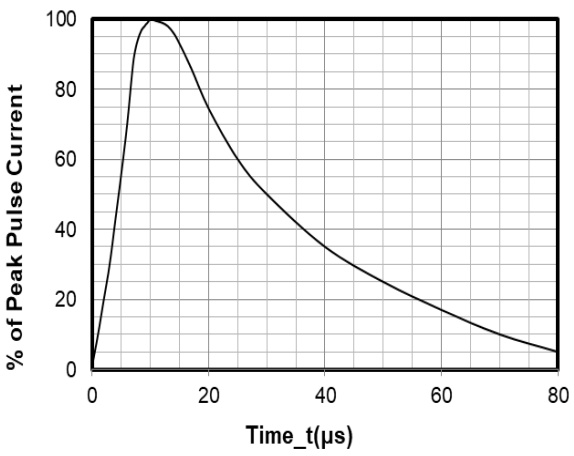
Peak Pulse Power vs. Pulse Time



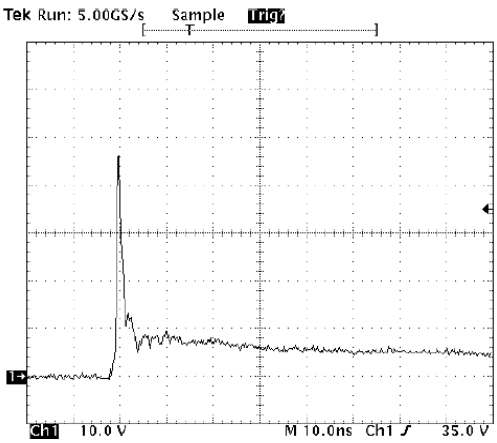
Clamping Voltage vs. Peak Pulse Current



Power Derating Curve



8 X 20μs Pulse Waveform

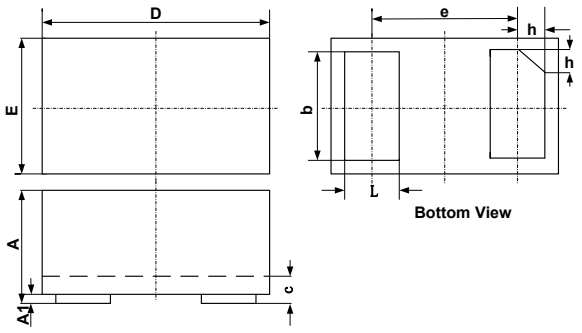


Note：Data is taken with a 10x attenuator

ESD Clamping Voltage

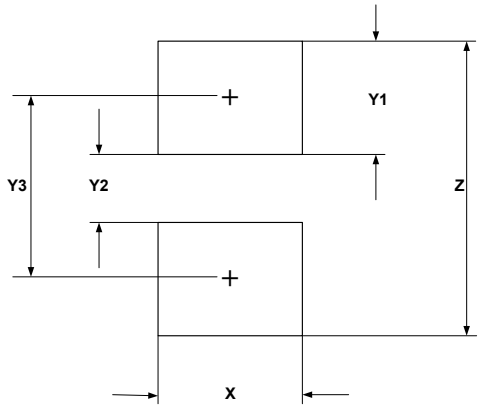
8 kV Contact per IEC61000−4−2

DFN1006 PACKAGE OUTLINE & DIMENSIONS



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.45	0.50	0.55	0.018	0.020	0.022
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.45	0.50	0.55	0.018	0.020	0.022
c	0.12	0.15	0.18	0.005	0.006	0.007
D	0.95	1.00	1.05	0.037	0.039	0.041
e	0.65 BSC			0.026 BSC		
E	0.55	0.60	0.65	0.022	0.024	0.026
L	0.20	0.25	0.30	0.008	0.010	0.012
h	0.07	0.12	0.17	0.003	0.005	0.007

Suggested Land Pattern



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
X	0.60	0.024
Y1	0.50	0.020
Y2	0.30	0.012
Y3	0.80	0.032
Z	1.30	0.052

Shanghai Leiditech Electronic Co.,Ltd
Email: sale1@leiditech.com
Tel : +86- 021 50828806
Fax : +86- 021 50477059